PRODUCT / PROCESS CHANGE NOTIFICATION

1. PCN basic data		
1.1 Company	577	STMicroelectronics International N.V
1.2 PCN No.		AMS/21/12593
1.3 Title of PCN		Reflow profile recommendation for selected BlueNRG modules
1.4 Product Category		See product list
1.5 Issue date		2021-03-09

2. PCN Team		
2.1 Contact supplier		
2.1.1 Name	NEMETH KRISZTINA	
2.1.2 Phone	+49 89460062210	
2.1.3 Email	krisztina.nemeth@st.com	
2.2 Change responsibility		
2.2.1 Product Manager	Marco VENERI	
2.1.2 Marketing Manager	Marco VENERI	
2.1.3 Quality Manager	Jean-Marc BUGNARD	

3. Change		
3.1 Category	3.2 Type of change	3.3 Manufacturing Location
General Product & Design	Modification of datasheet : Errata/error fix	Back end plant : ASE Korea

4. Description of change		
	Old	New
4.1 Description	Peak temperature (Tp) = 245 (-0) °C Time within 5°C of peak temperature (Tp-5°C) = min 30 s	Peak temperature (Tp) = 240 + 0 °C Time within 5°C of peak temperature (Tp-5°C) = 10-20 sec
4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?	No impact	

5. Reason / motivation for change		
5.1 Motivation To avoid any prohibited liquidus state of module solder joints during custo		
5.2 Customer Benefit	QUALITY IMPROVEMENT	

6. Marking of parts / traceability of change		
6.1 Description	N/A	

7. Timing / schedule		
7.1 Date of qualification results	2021-02-01	
7.2 Intended start of delivery	2021-05-15	
7.3 Qualification sample available?	Upon Request	

8. Qualification / Validation			
8.1 Description	escription 12593 BLUENRG-Modules_Reflow_Profile_Change.pdf		
8.2 Qualification report and qualification results		Issue Date	2021-03-09

9. Attachments (additional documentations)
12593 Public product.pdf 12593 BLUENRG-Modules_Reflow_Profile_Change.pdf

10. Affected parts		
10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No 10.1.2 Supplier Part No 10.1.2 Supplier Part No		10.1.2 Supplier Part No
3387323	BLUENRG-M2SP	

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